

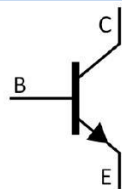
/ Descriptions

/ Features

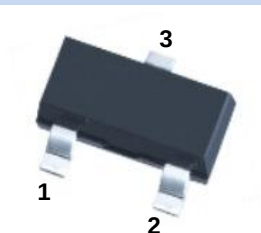
/ Applications

μ

/ Equivalent Circuit



/ Pinning



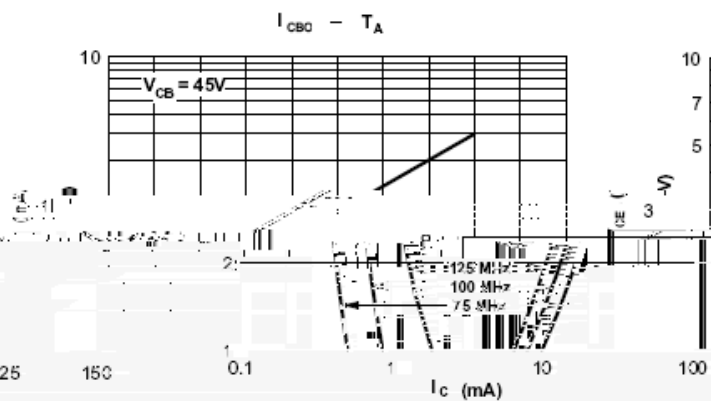
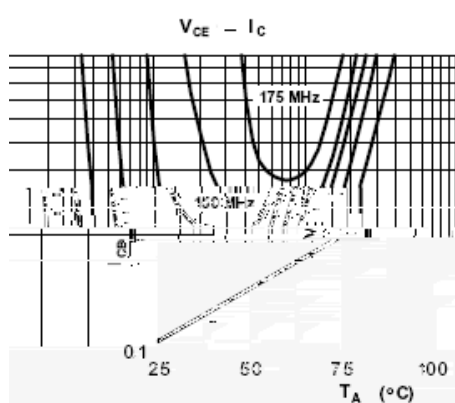
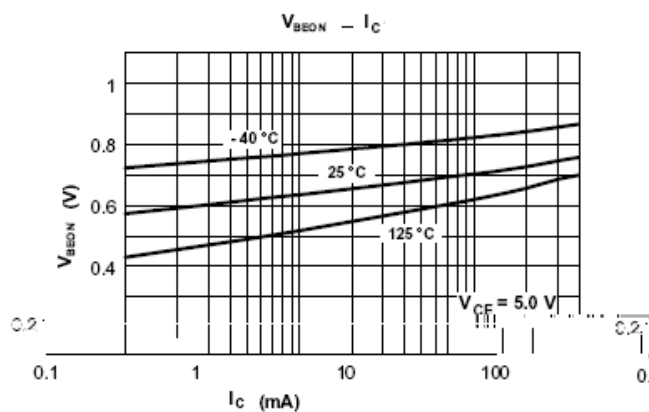
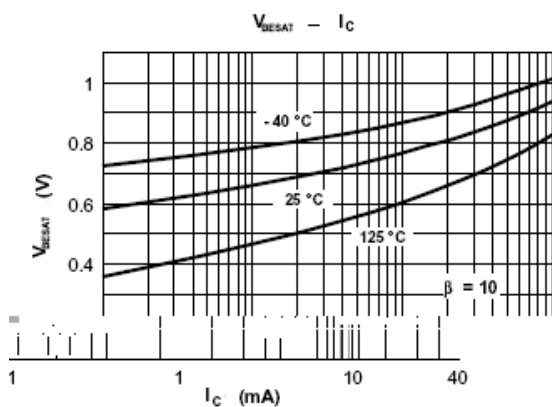
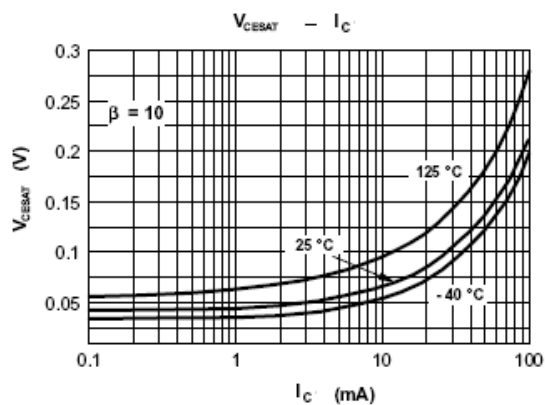
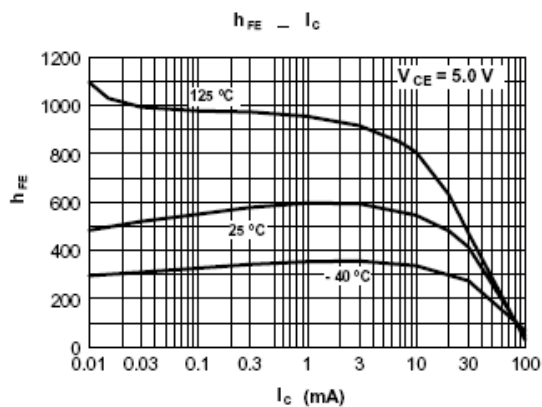
/ h_{FE} Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

/ Electrical Characteristics(Ta=25)

		μ				
		μ				

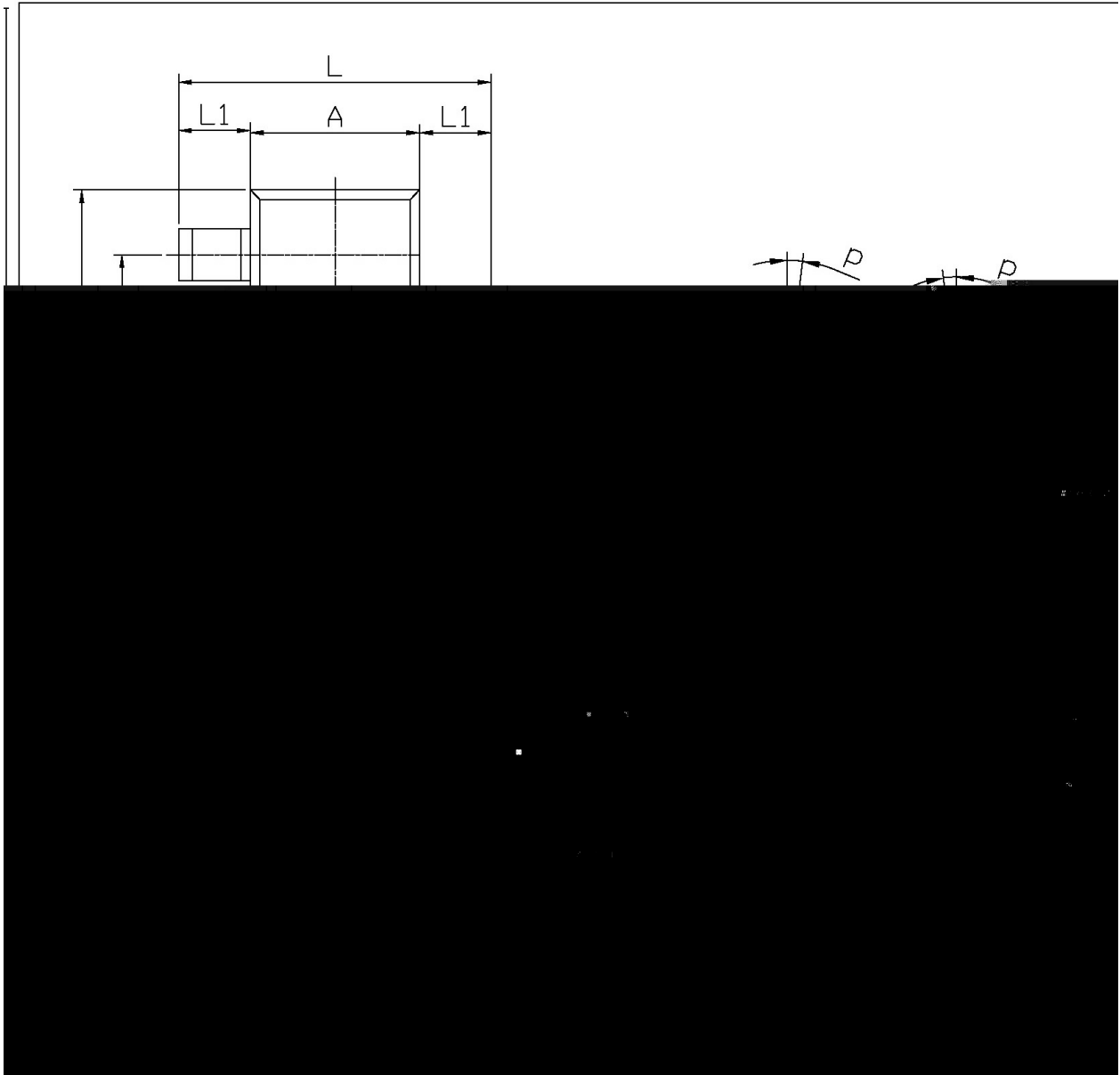
/ Electrical Characteristic Curve



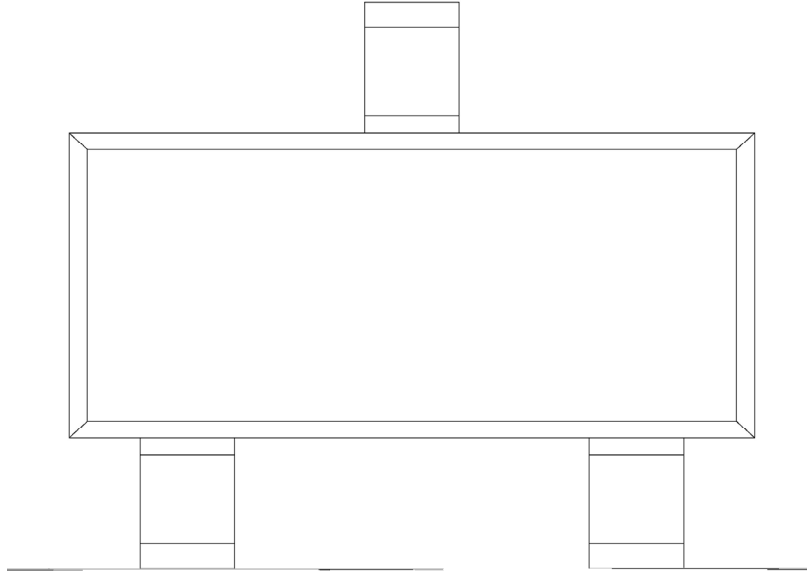
/ Package Dimensions

SOT-23

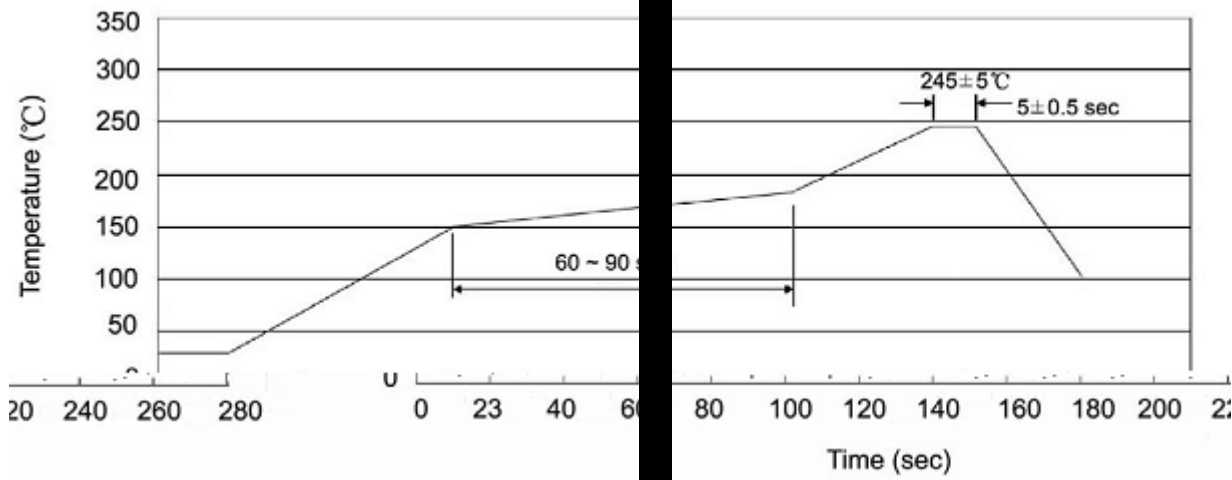
单位: mm



/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

封装形式	包装数量						包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱			Units/Outer Box 只/箱	Reel	Inner Box 盒
SOT-23	3,000	10	30,000	6		180,000	7 ×8	180×120×180	390×385×205